



## Mr. JOSE RHETT MAGBANUA DOMINO

Bachelor of Science in Electronics Engineering | TUP-V SY2001

**ELECTRONICS REPAIR-MODIFICATION-ALTERNATIVE SOLUTION**

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### CAREER OBJECTIVE

**With over 20years of experience in electronics industry -I will bring the next level of cost saving strategy and electronics repair service capability into your company.**

- Complex repair capability
- Electronic parts modification
- Building testing stations
- Obsolete parts substitute and alternative solution
- Smart spare part sourcing and inventory
- Trainings and info-sharing sessions

### EMPLOYMENT HISTORY

Sep2021- Present	Infineon Technologies Kulim Malaysia (FE semiconductor wafer fab) <b>Senior Staff Engineer</b>   Inhouse equipment-electronic-parts repair service   Process control and automation
Dec2015-Sep2021	Infineon Technologies Kulim Malaysia (FE semiconductor wafer fab)   2yrs <b>Staff Engineer</b>   Inhouse equipment-electronic-parts repair service
Dec2012-Dec2015	Infineon Technologies Kulim Malaysia (FE semiconductor wafer fab)   3yrs <b>Senior Engineer</b>   Inhouse equipment-electronic-parts repair service
May2010-Dec2012	Flextronics Technology Malaysia (PCB Assembly)   2.5yrs <b>Associate Debug Engineer</b>   Xyratex servers & controllers repair
Dec2002-May2010	Teradyne Philippines Ltd (Teradyne Testers Repair Service)   7.4yrs <b>Test/Repair Engineer</b>   Board repair A565/IntegraFlex/UltraFlex
Aug2001-Dec2002	Saturn Electronics Philippines Inc. (PCB Assembly)   1.3yrs <b>Test Technician</b>   Functional testers troubleshooting (Hitachi/Honda)

### AREAS OF EXPERTISE

- Industrial Electronics Part's Modification
- Obsolete Electronic Components Substitute
- Industrial Electronics Parts Repair
- Components Level Troubleshooting
- SMD/PTH Complex Soldering Rework
- Electronic Parts Reverse Engineering
- Semiconductor Wafer Fab Equipment
- Industrial SMPS, Computers, VFD, RF Gen
- Programming/Automation Python, C++, VBA
- Technical Papers Submission and Presentation

### PROJECTS, ACHIEVEMENTS, AND COST SAVINGS

- Completed 20 projects, \$800K cost saving
- Repaired 112 electronic parts, \$990K cost saving
- Rank-1 in YIP, submitted 76 ideas
- Completed 5 technical papers & 2 inventions
- Star award by saving \$20K board from scrap
- Special award by recovering critical equipment
- Wafer cross-crack detection, save \$240K
- Tester failure detection, save \$207K

### INTERNATIONAL TRAININGS

• Electronics repair service cross training (2Wks Sept2014) Germany, Austria	Infineon
• Ultra-Flex Automatic Test Equipment Training (6mo May2006) USA	Teradyne
• Catalyst/A565 Automatic Test Equipment Training (3mo Nov2003) USA	Teradyne

### CHARACTER REFERENCES

• Andrew Yeap   +60175150180   Director   Infineon Kul	Malaysia
• Pragash Rao Asooria   +60 124182276   Senior Director   Infineon Kul	Malaysia
• Tabali Santha Kumar   +4367682057054   Principal Engineer   Infineon Vil	Austria
• John Paul Zante   +61499490129   Customer Support Manager   Beam Comm	Australia